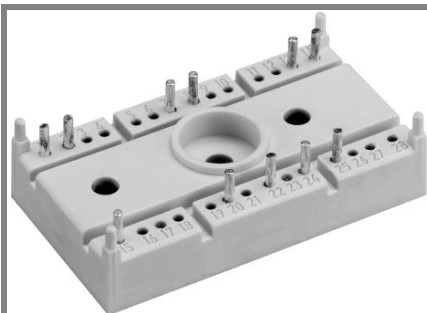


SK 50 GH 065 F



SEMITOP® 3

IGBT Module

SK 50 GH 065 F

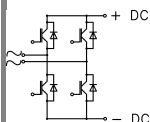
Target Data

Features

- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonding aluminium oxide ceramic (DBC)
- Ultra fast NPT IGBT
- Turdo FWDiodes
- Low threshold voltage
- Low tail current with low temperature dependence

Typical Applications

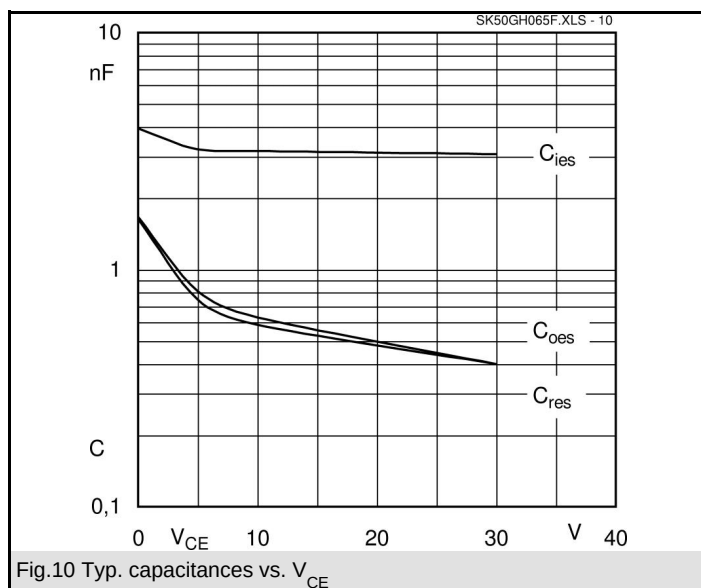
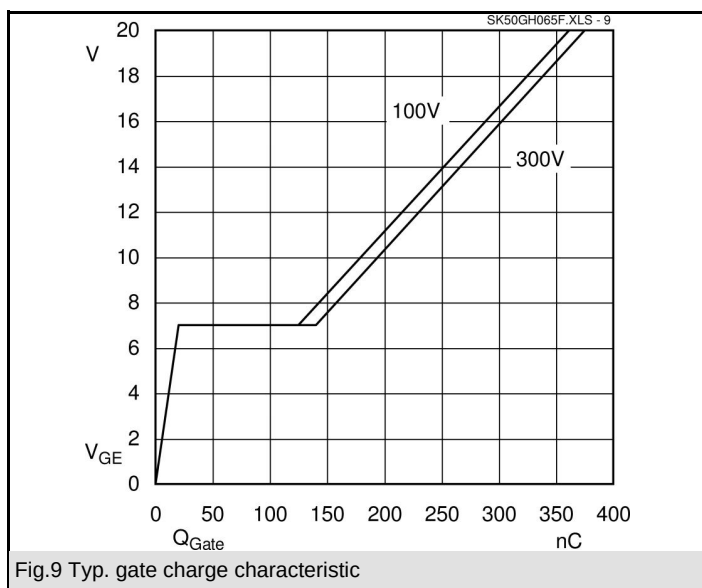
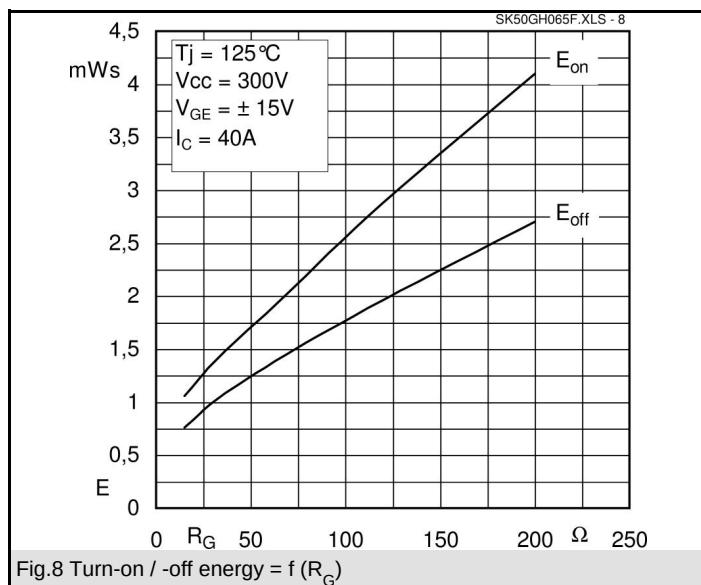
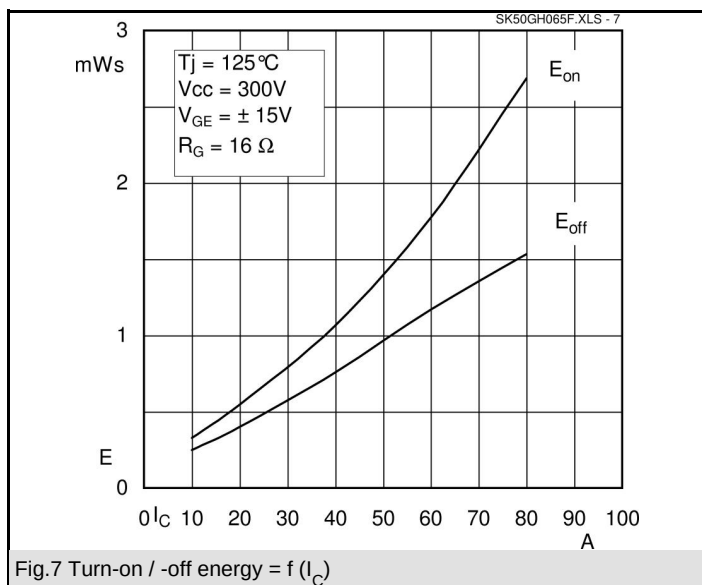
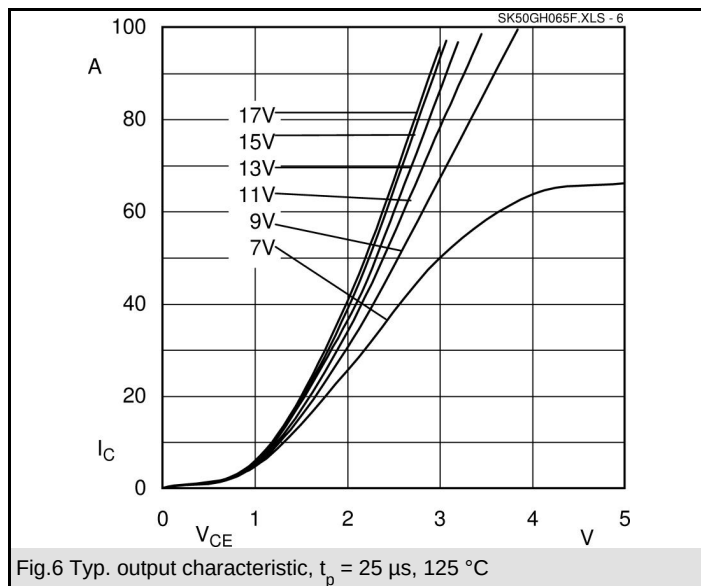
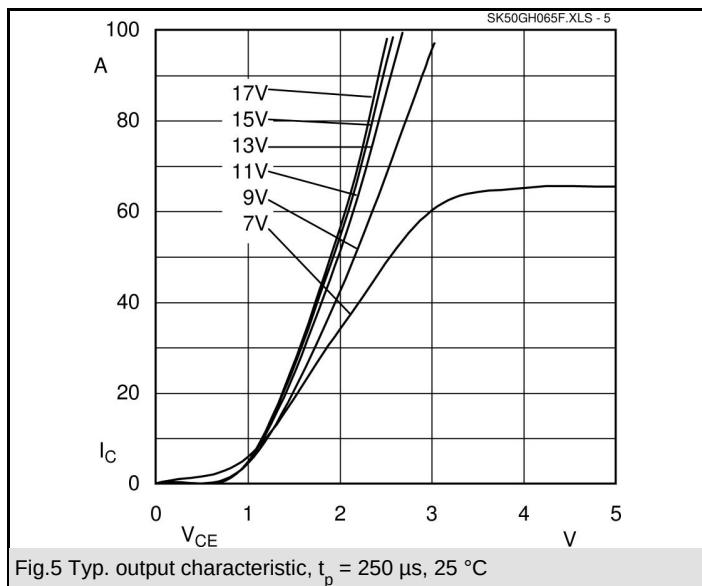
- Switching (not for linear use)
- Inverter
- Switched mode power supplies
- UPS

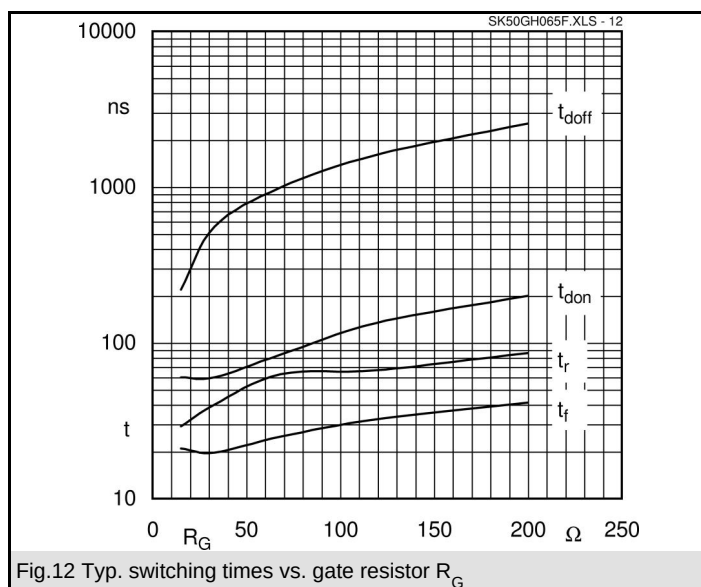
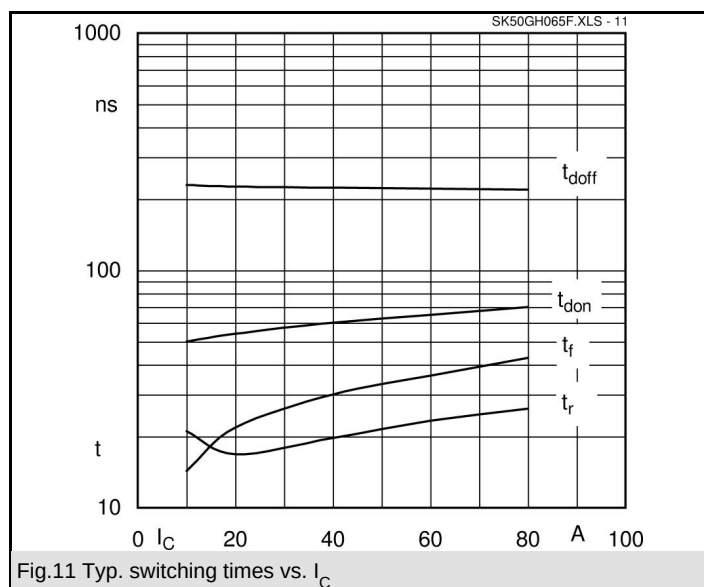


GH

Absolute Maximum Ratings		$T_s = 25\text{ °C}$, unless otherwise specified	
Symbol	Conditions	Values	Units
IGBT			
V_{CES}		600	V
V_{GES}		± 20	V
I_C	$T_s = 25\text{ (80) °C}$;	54 (40)	A
I_{CM}	$t_p < 1\text{ ms}$; $T_s = 25\text{ (80) °C}$;	108 (80)	A
T_j		- 40 ... + 150	°C
Inverse / Freewheeling Diode			
I_F	$T_s = 25\text{ (80) °C}$;	82 (50)	A
$I_{FM} = -I_{CM}$	$t_p < 1\text{ ms}$; $T_s = 25\text{ (80) °C}$;	164 (100)	A
T_j		- 40 ... + 150	°C
T_{stg}		- 40 ... + 125	°C
T_{sol}	Terminals, 10 s	260	°C
V_{isol}	AC 50 Hz, r.m.s. 1 min. / 1 s	2500 / 3000	V

Characteristics		$T_s = 25\text{ °C}$, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT					
$V_{CE(sat)}$	$I_C = 40\text{ A}$, $T_j = 25\text{ (125) °C}$		1,7 (2,2)	2 (2,2)	V
$V_{GE(th)}$	$V_{CE} = V_{GE}$; $I_C = 0,0014\text{ A}$	4,5	5,5	6,5	V
C_{res}	$V_{CE} = 25\text{ V}$; $V_{GE} = 0\text{ V}$; 1 MHz		3		nF
$R_{th(j-s)}$	per IGBT			0,85	K/W
	per module				K/W
$t_{d(on)}$	under following conditions: $V_{CC} = 300\text{ V}$, $V_{GE} = \pm 15\text{ V}$				ns
t_r	$I_C = 40\text{ A}$, $T_j = 125\text{ °C}$				ns
$t_{d(off)}$	$R_{Gon} = R_{Goff} = 16\text{ }\Omega$				ns
t_f					ns
$E_{on} + E_{off}$	Inductive load		1,8		mJ
Inverse / Freewheeling Diode					
$V_F = V_{EC}$	$I_F = 60\text{ A}$; $T_j = 25\text{ (125) °C}$		1,1		V
$V_{(TO)}$	$T_j = (125)\text{ °C}$		(0,85)		V
r_T	$T_j = (125)\text{ °C}$		(3,55)		mΩ
$R_{th(j-s)}$				1,1	K/W
I_{RRM}	under following conditions: $I_F = \text{A}$; $V_R = 300\text{ V}$				A
Q_{rr}	$di_F/dt = \text{A}/\mu\text{s}$				μC
E_{off}	$V_{GE} = 0\text{ V}$; $T_j = 125\text{ °C}$				mJ
Mechanical data					
M1	mounting torque	2,3		2,5	Nm
w			30		g
Case	SEMITOP® 3		T 19		

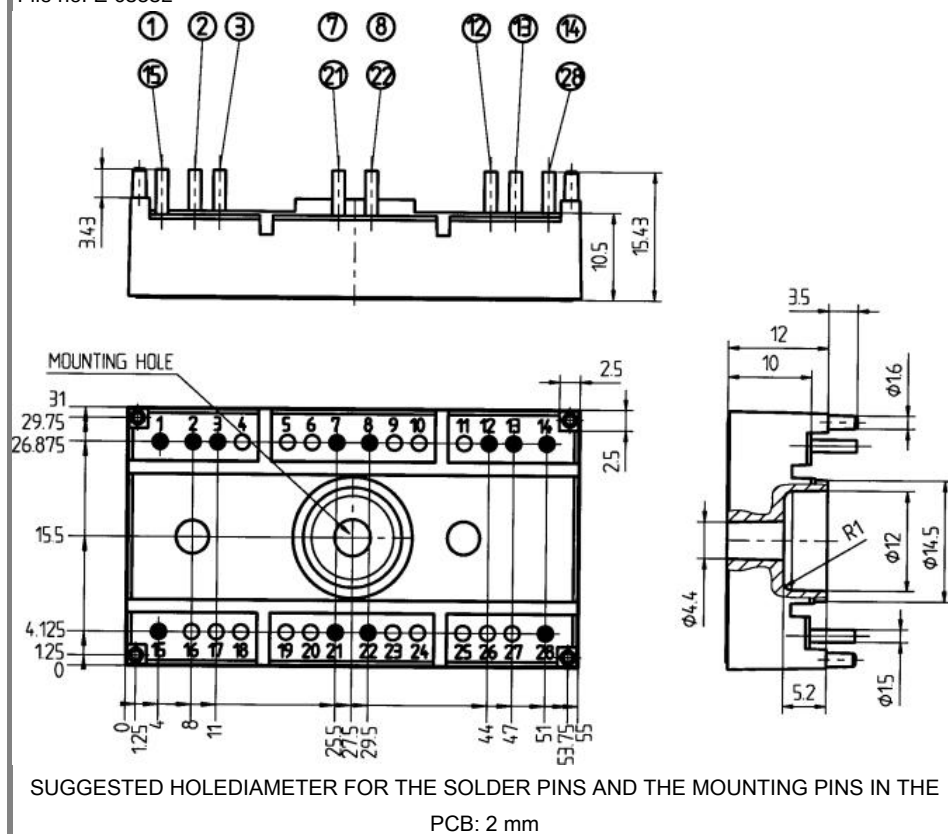




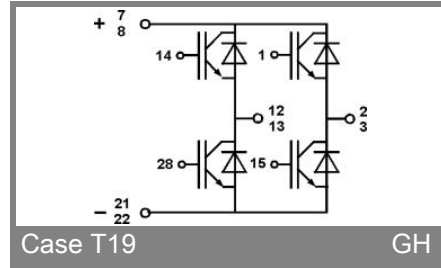
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UL Recognized
File no. E 63532

Dimensions in mm



Case T19



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.